The background image shows a close-up of a photonic integrated circuit (PIC) assembly. A green printed circuit board (PCB) is populated with various electronic components, including a central integrated circuit. A metal carrier or test socket is mounted on the PCB, holding several fiber optic cables. A thin, transparent fiber is being precisely aligned and coupled to a component on the PIC. The assembly is held together by screws and is mounted on a metal base.

# Direct coupling of a laser-written photonic integrated circuit to a SPAD array



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MILANO 1863



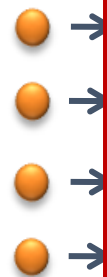
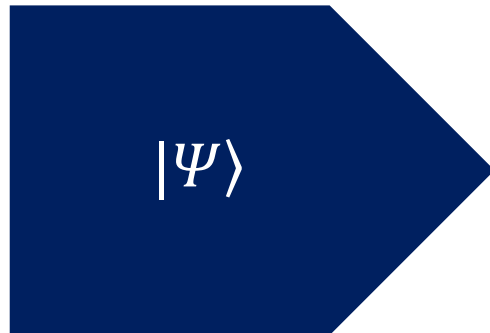
**CNR IFN**  
Istituto di Fotonica e Nanotecnologie

# Quantum information processing



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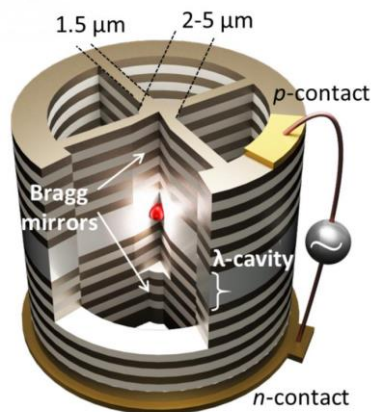
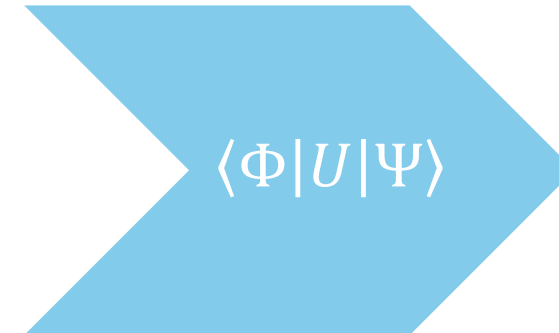
## QUANTUM STATE GENERATION



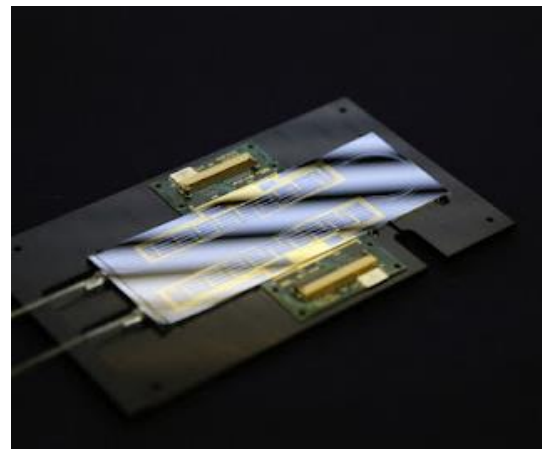
## QUANTUM STATE MANIPULATION



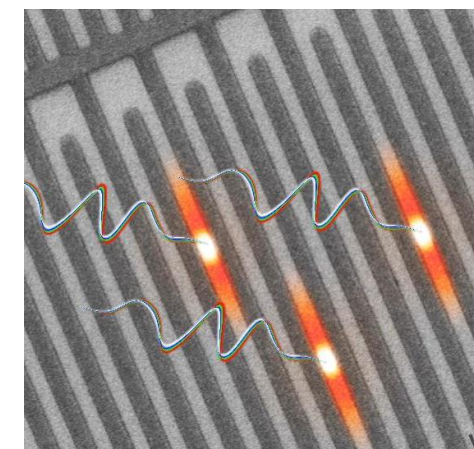
## QUANTUM STATE DETECTION



Somaschi et al. *Nature Photonics* 10.5 (2016): 340-345.



Carolan et al. *Science* 349.6249 (2015): 711-716.



Cahall et al. *Optica* 4.12 (2017): 1534-1535.

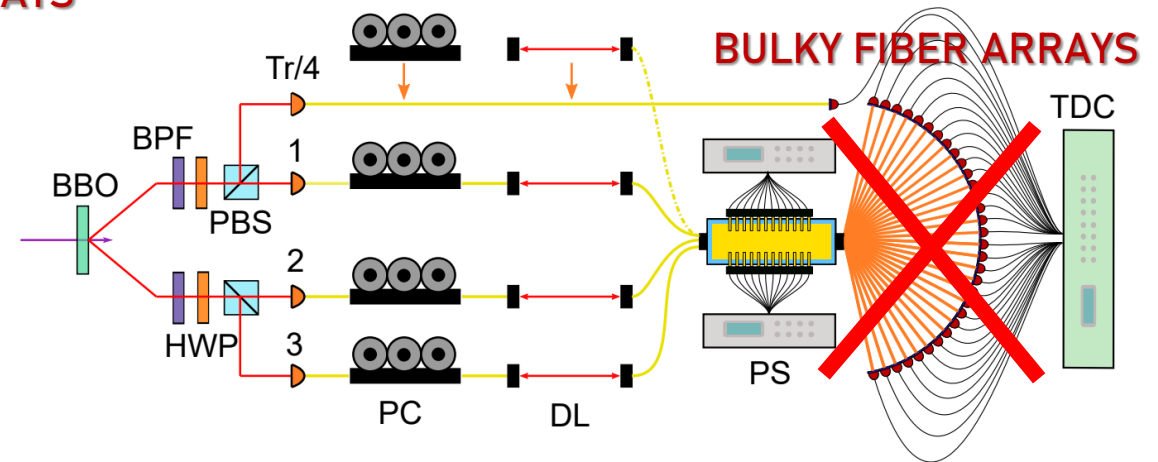
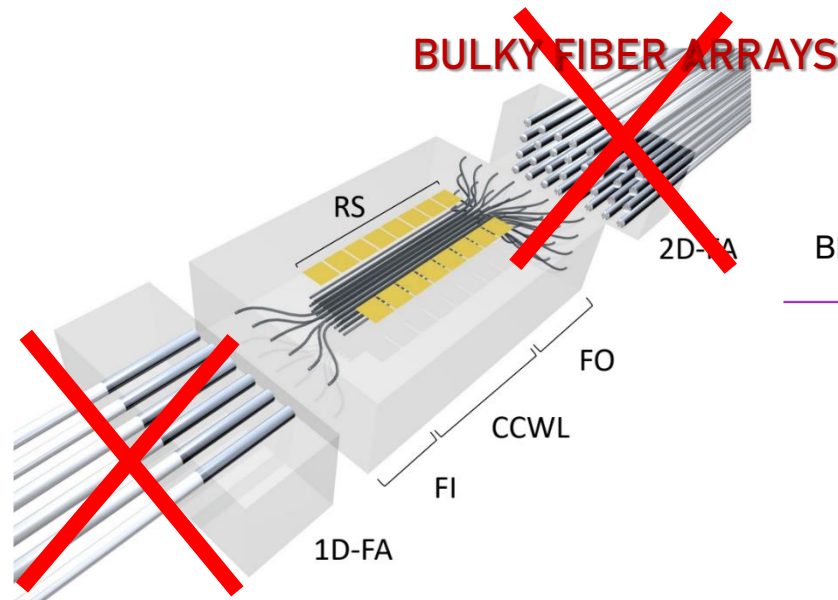
# Focus on scalability

Scalability is critical to enable increasingly complex algorithms

Up to date obstacles to scalability:

- Detector operating at cryogenic temperature (huge footprint and high power consumption)
- Bulky interconnections between manipulation and detection part

Superconduction Single  
Photon Detection Cryostat



Hoch et al. *npj Quantum Information* 8.1 (2022): 55.

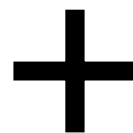
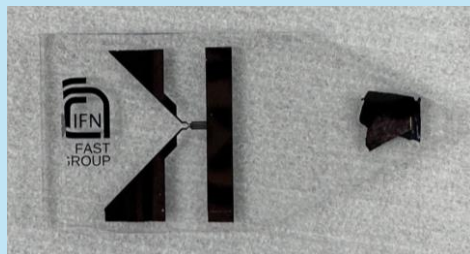
INTEGRATED SYSTEM

- room temperature
- high system efficiency

# Hybrid Integration

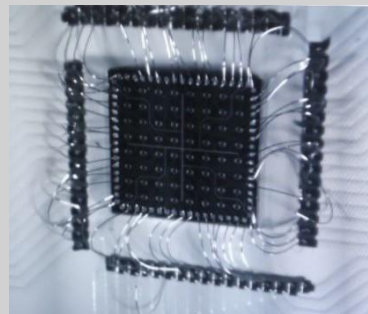
Photonic Integrated  
Circuit (PIC)

Femtosecond Laser Writing  
(FLW) on GLASS

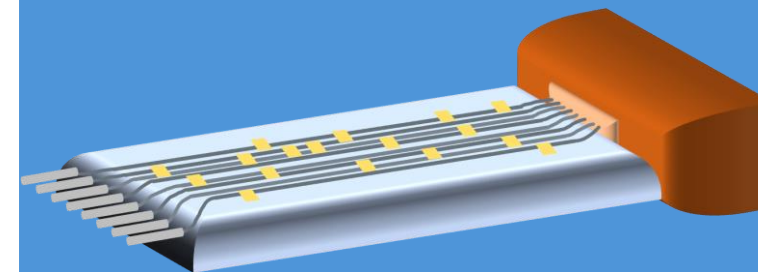


Single Photon Avalanche  
Diode Arrays (SPADs)

Custom silicon technology



**HYBRID INTEGRATION**



Direct coupling

Custom technology to deliver  
state-of-the-art performances  
for the intended technology



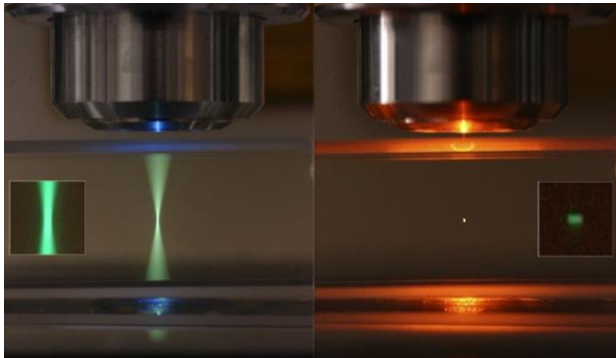
Compact system without  
compromising on efficiency

# Femtosecond Laser Writing



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High energy pulses trigger non-linear absorption process that induce a permanent modification in the transparent material

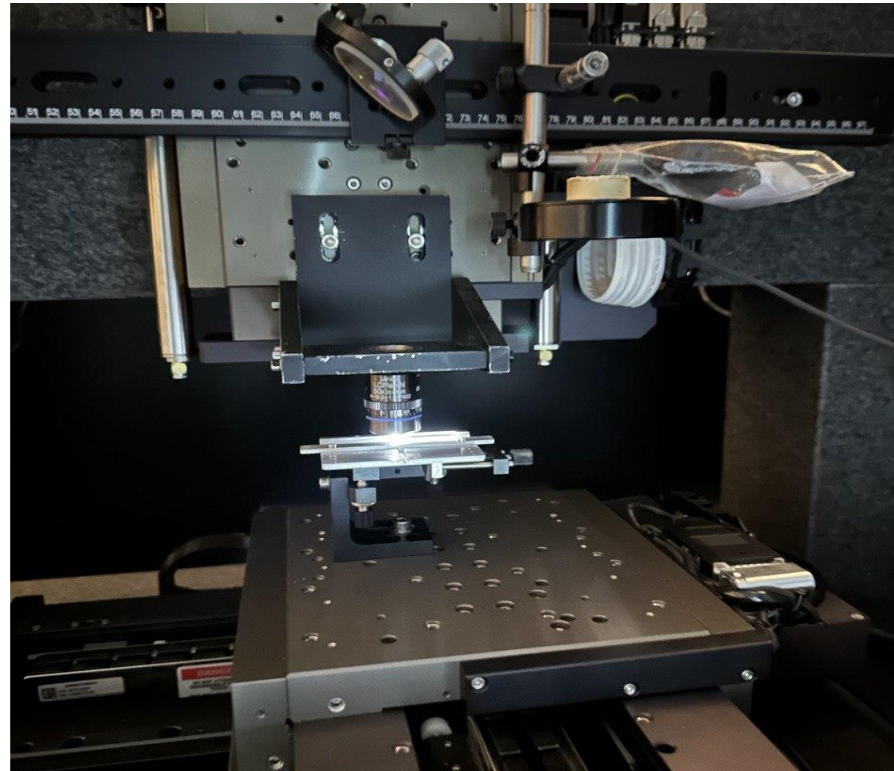


Linear  
absorption

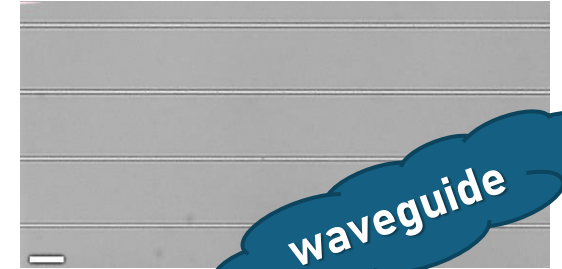
Non-linear  
absorption

In the non-linear process  
the absorption occur only  
in the focal volume

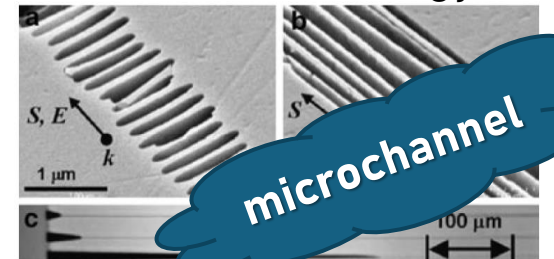
3D



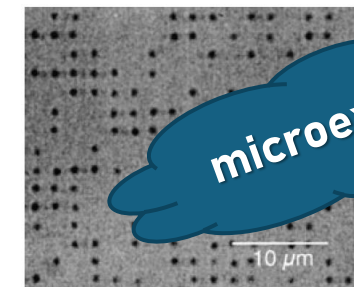
Low energy



Intermediate energy



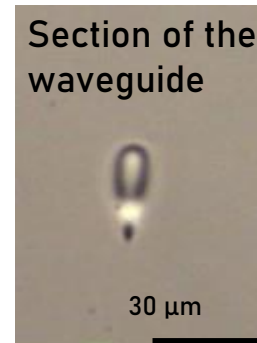
High energy



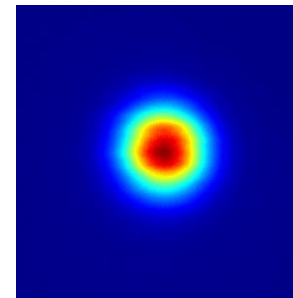
# Waveguide with FLW

- Low propagation losses  
Around 0.1 dB/cm
- Low Coupling losses  
Around 0.2 dB
- 3D capabilities  
Perfect for coupling to 2D arrays
- Versatile technique  
process a wide range of materials  
and for each we can optimize the  
process for every wavelength

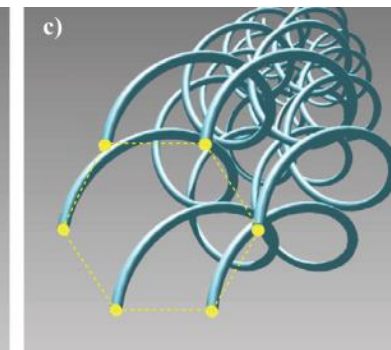
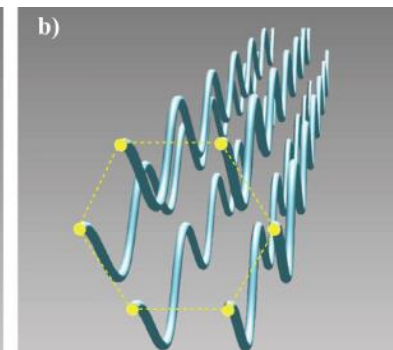
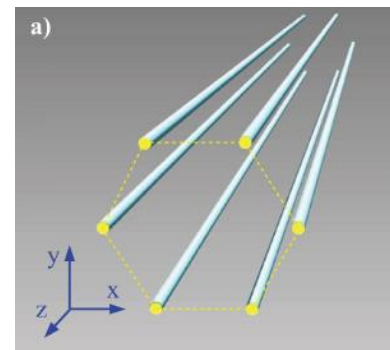
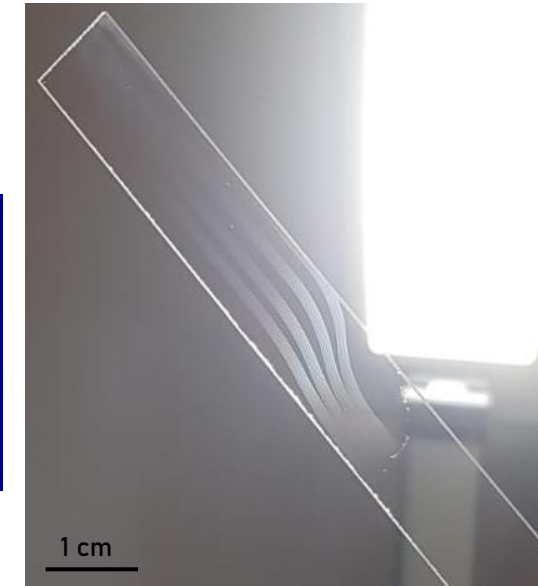
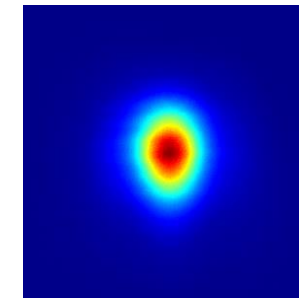
- Small volume capability  
fabrication of a few chips at a time
- Low change in refractive index  
Around  $\Delta n \sim 10^{-3}$



Fiber SM 450  
@532nm



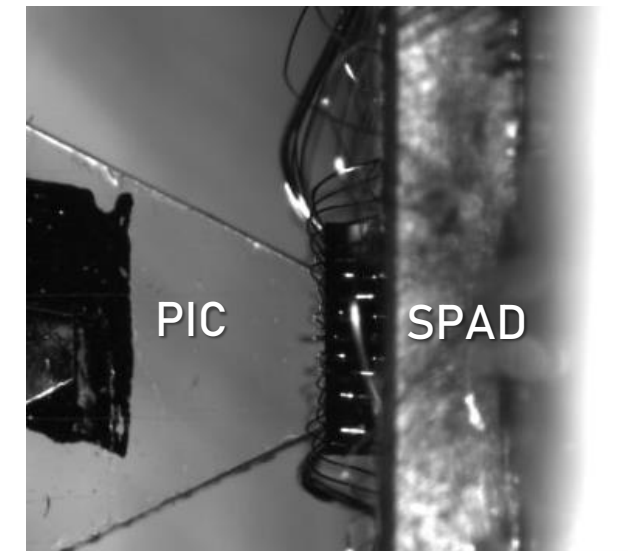
Waveguide



A. Crespi *et al* 2013 *New J. Phys.* 15 013012

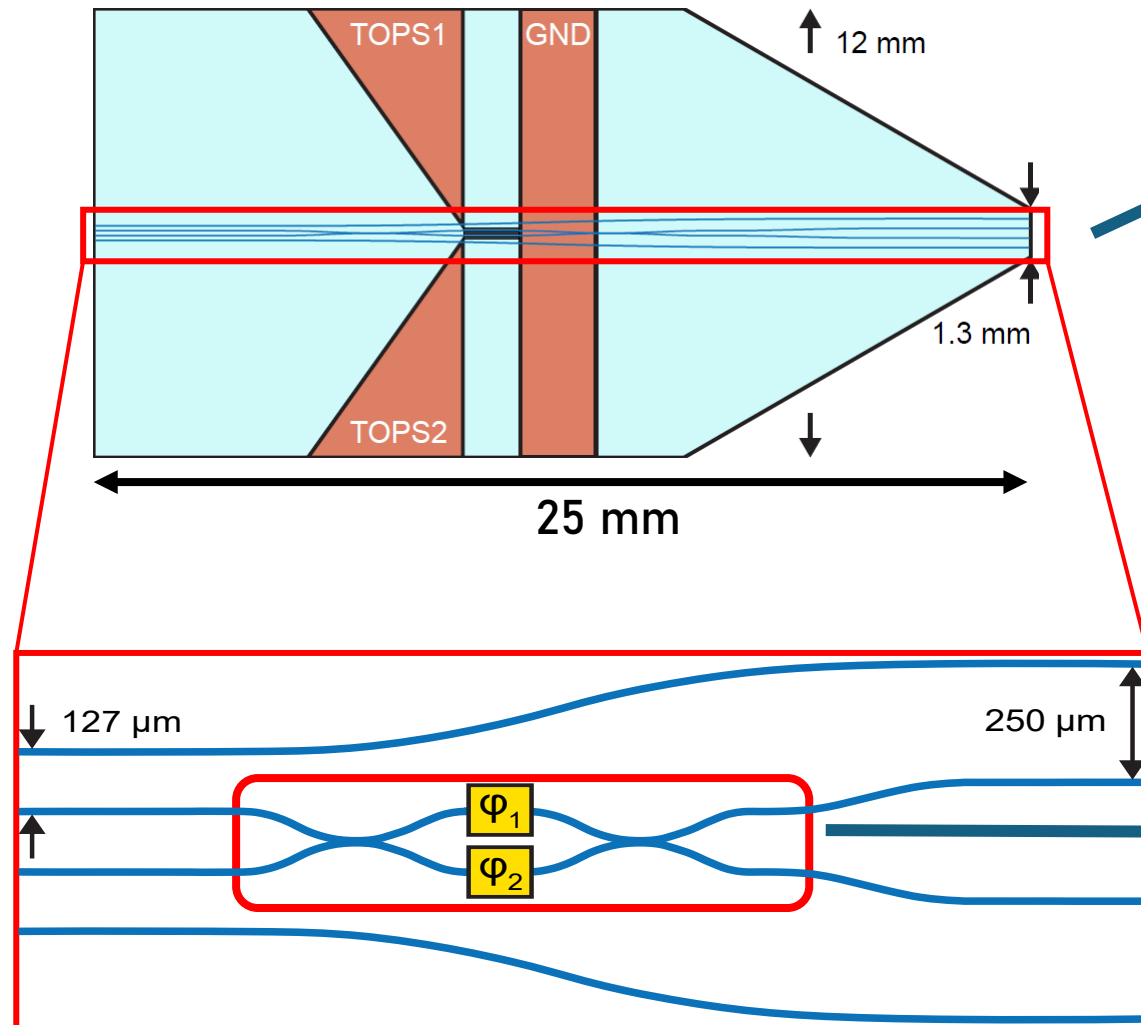
# Design of the PIC

Pointed shape for  
coupling with the SPAD



PIC

SPAD

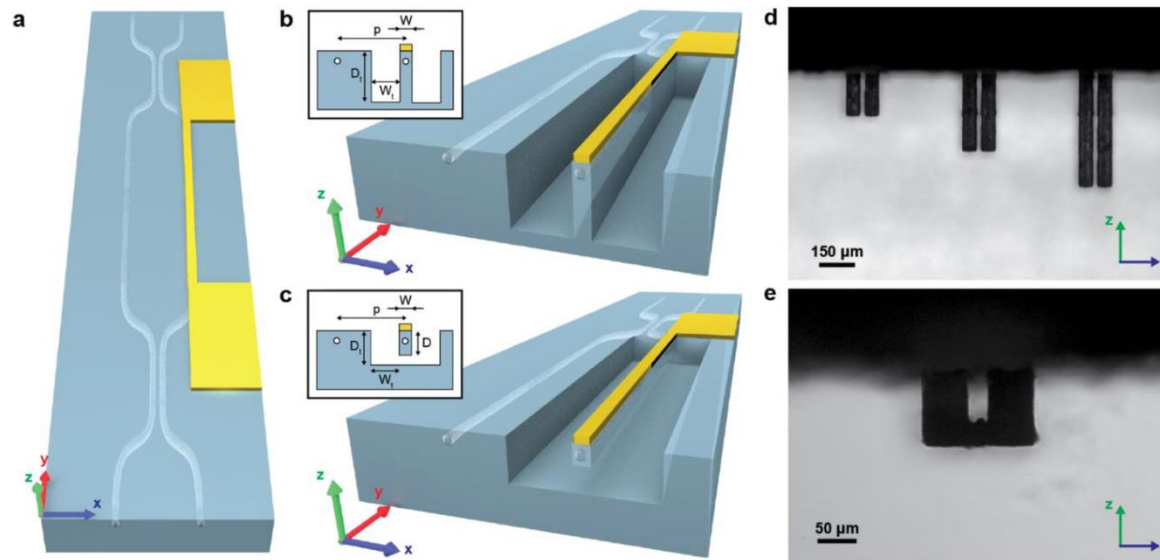


A reconfigurable MZI implemented through two thermo-optic phase shifters (TOPSs).  
Building block to realize Universal Photonic Processor (UPP)

# Trench and resistor fabrication

## Thermal Isolation

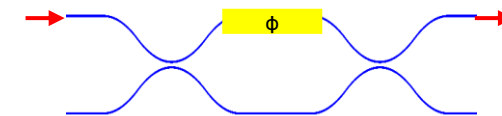
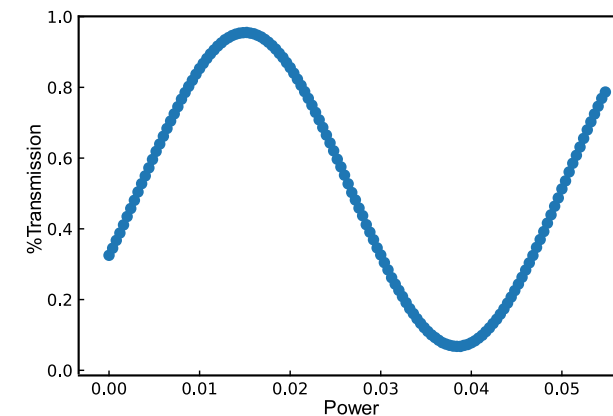
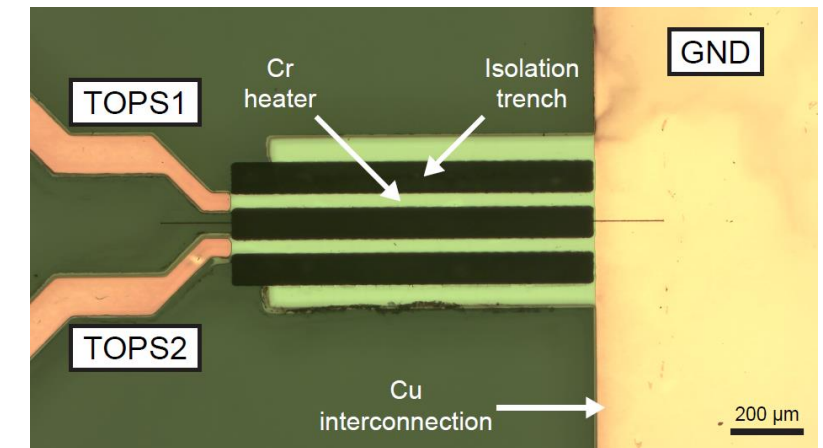
- Reduce the working power of the TOPS
- Reduce the thermal cross talk



Ceccarelli et al. *Laser & Photonics Reviews* 2020  
Low Power Reconfigurability and Reduced Crosstalk in Integrated Photonic Circuits  
Fabricated by Femtosecond Laser Micromachining

## 2-step photolithography

Cromium  $\rightarrow$  high resistivity for higher heat dissipation  
Copper  $\rightarrow$  low resistivity for the interconnection



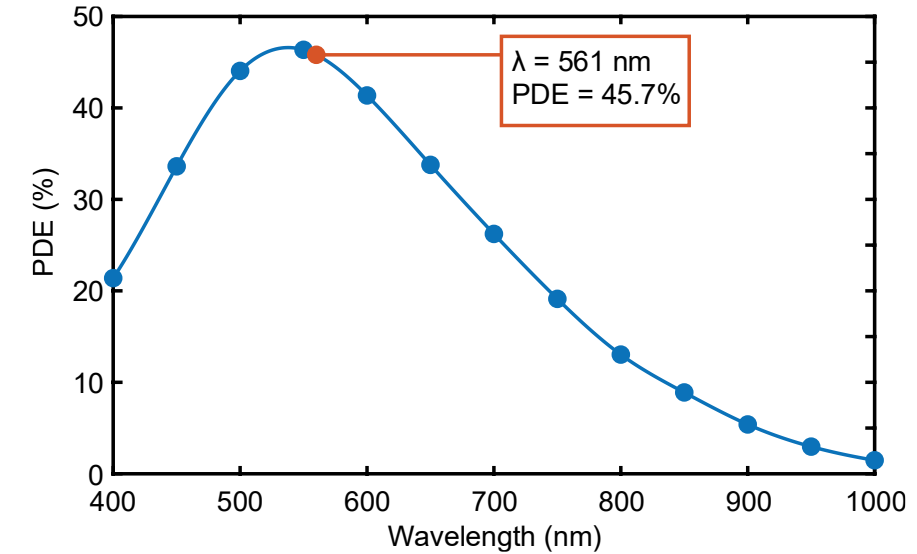
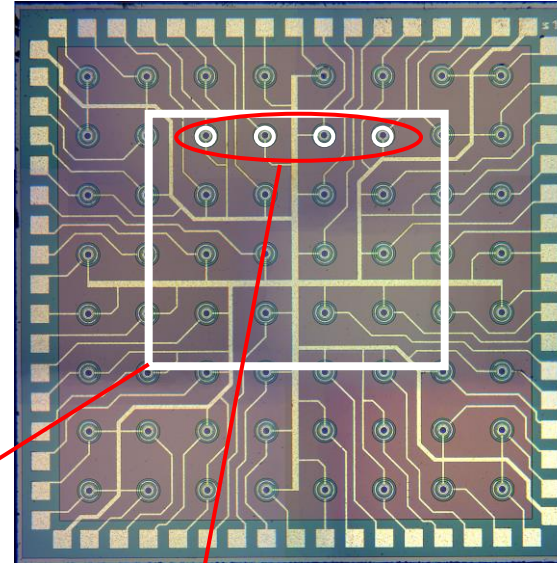


## CUSTOM-TECHNOLOGY THIN SPAD ARRAY

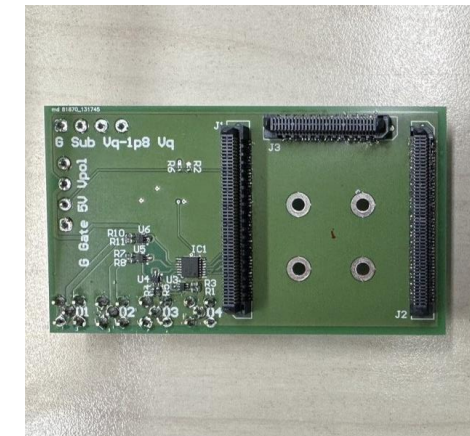
- Large pitch (250  $\mu\text{m}$ )
- 20  $\mu\text{m}$  single SPAD diameter
- Low number of pixels (64, only 4 will be actually used)
- High detection efficiency in the visible range
- Relatively good DCR, afterpulsing, crosstalk, ecc.

Footprint of the FLW-PIC (1.3 x 1  $\text{mm}^2$ )

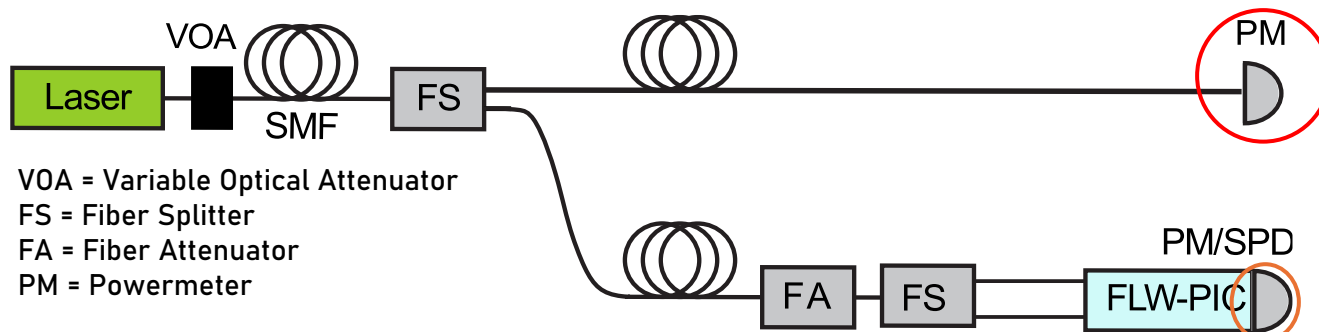
The four SPAD used in this experiment



The outputs of the selected active quenching circuits are buffered through an on-board circuit and made available by SMA connectors



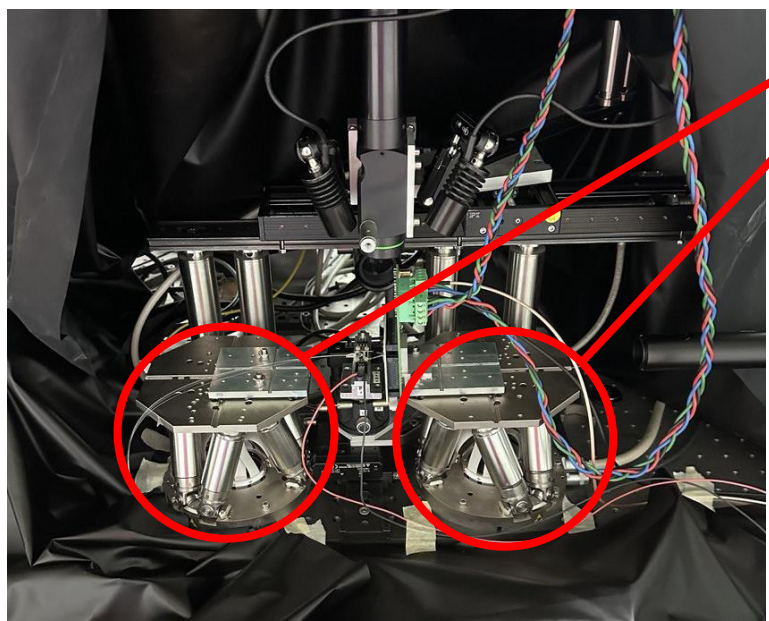
# Measurement Setup



VOA = Variable Optical Attenuator  
FS = Fiber Splitter  
FA = Fiber Attenuator  
PM = Powermeter

Setup adapted from T. Gerrits et al. Calibration of free-space and fiber-coupled single-photon detectors. *Metrologia*, 57(1):015002, 2020.

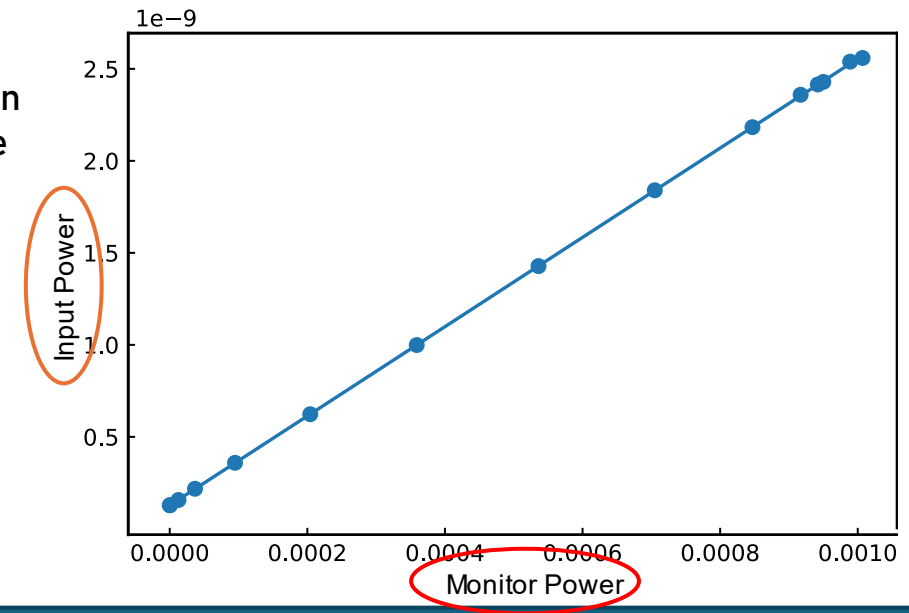
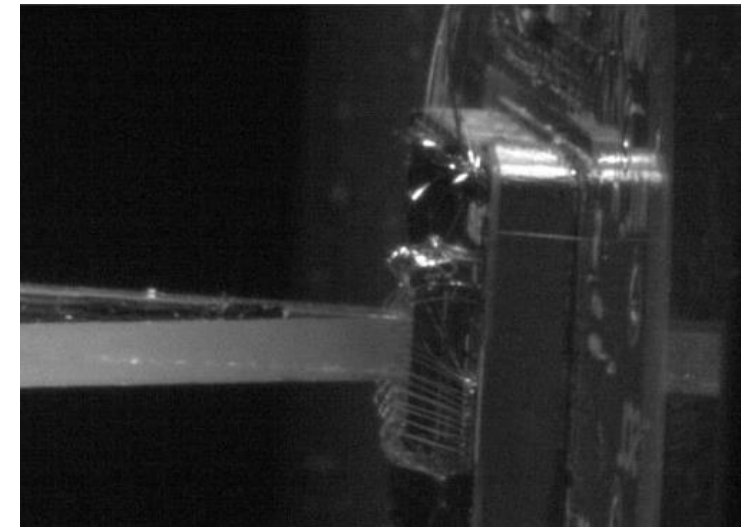
Measures inside black curtain



Hexapod

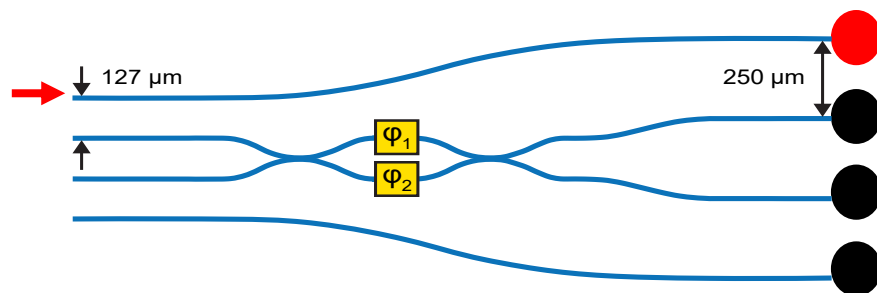
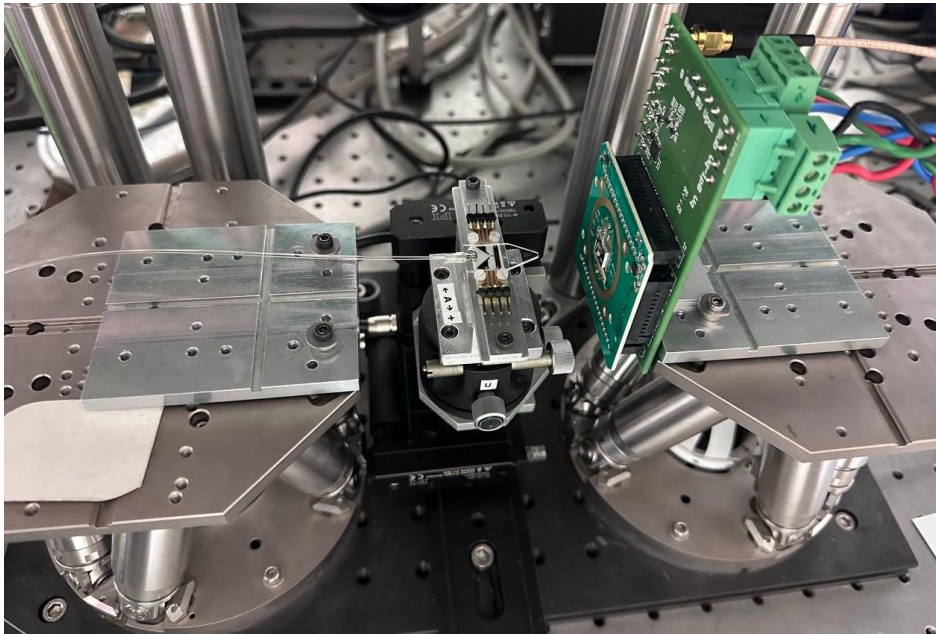
Thanks to the nanometer precision of hexapod we are able to achieve very precise coupling

Attenuation = -56.15 dB



# Linearity Measurement

Automated Measurement by scanning the intensity with VOA



Measurement at 561 nm

PIC transmission = 81.6%

SPAD features

$V_{\text{pol}} = 38.6 \text{ V}$

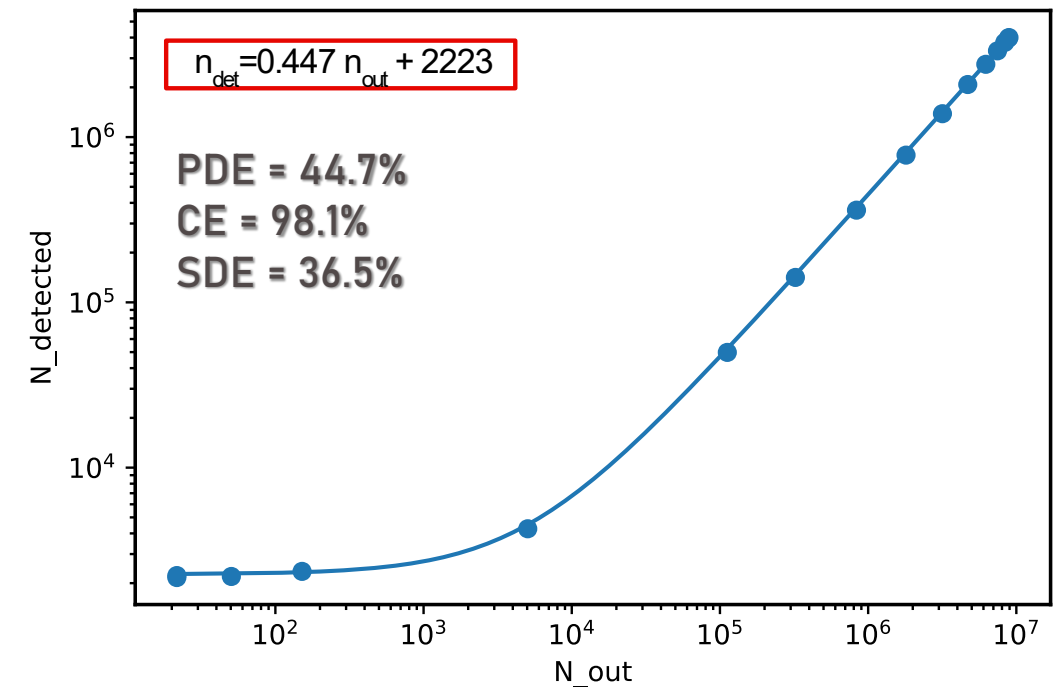
$V_{\text{ov}} = 5 \text{ V}$

$V_{\text{sub}} = 15 \text{ V}$

$T_{\text{gate}} = 1 \text{ s}$

DCR = 2223

Dead Time = 55 ns

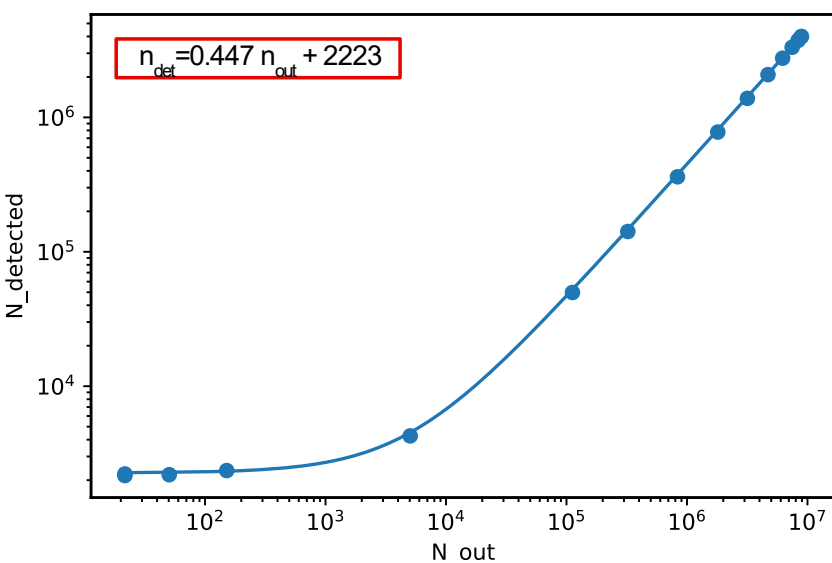


# Efficiencies for Different Overvoltages



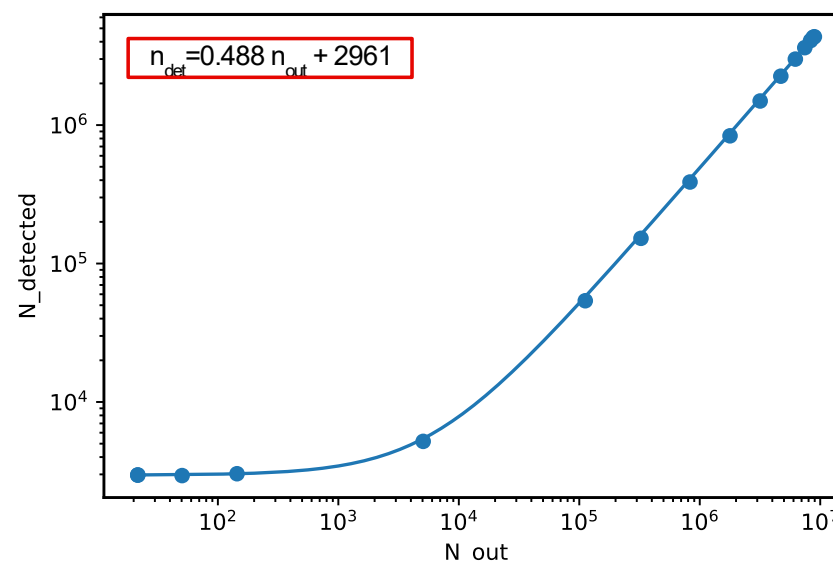
POLITECNICO  
MILANO 1863

$V_{ov}=5V$



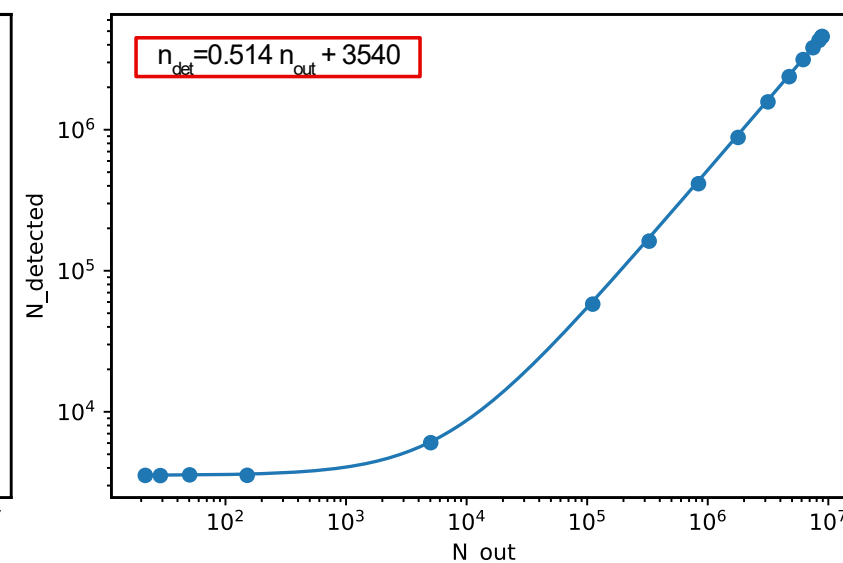
**PDE = 44.7%**  
**CE = 98.1%**  
**SDE = 36.5%**

$V_{ov}=6V$



**PDE = 48.8%**  
**CE = 98.1%**  
**SDE = 39.8%**

$V_{ov}=7V$

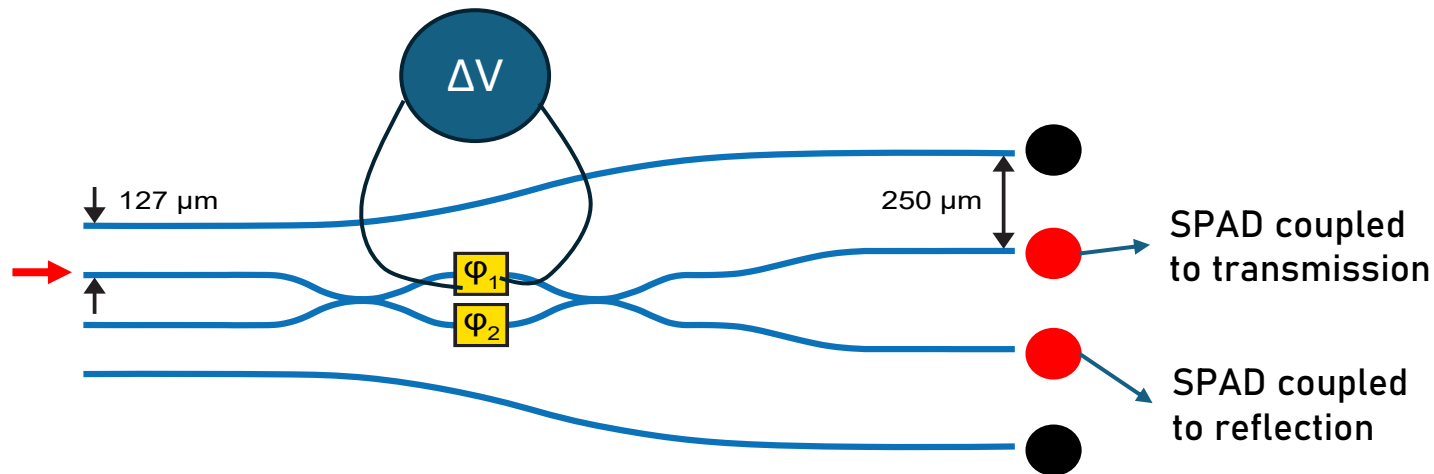


**PDE = 51.4%**  
**CE = 98.1%**  
**SDE = 41.9%**

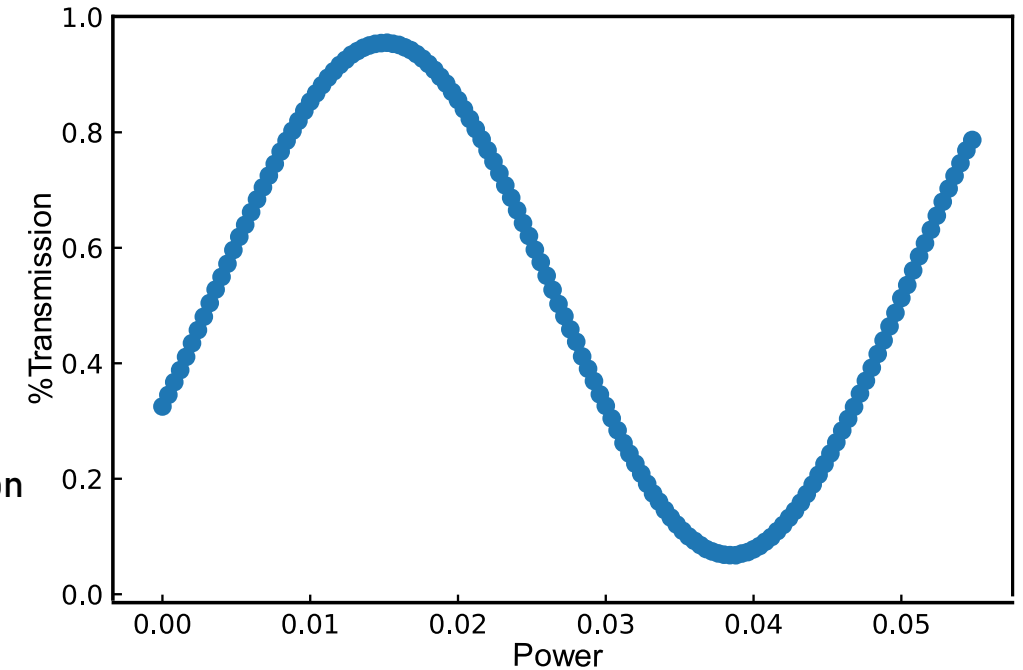
# Phase Shift measured with SPAD

## Measurement step

1. Tilt alignment using the 2 external straight waveguides
2. Change the input into the MZI and the relative SPAD
3. Simultaneous measurement of the two outputs
4. Normalization with respect the sum of the output



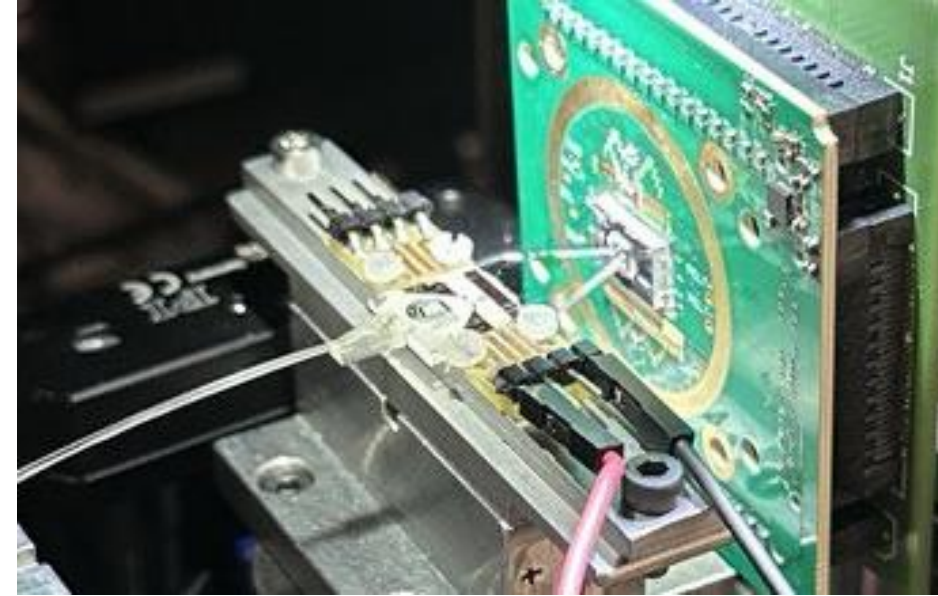
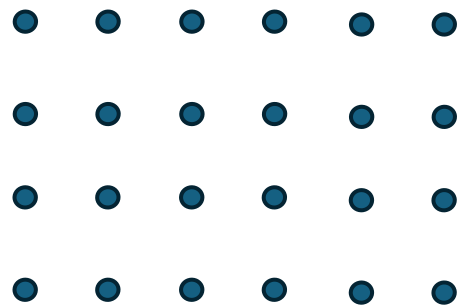
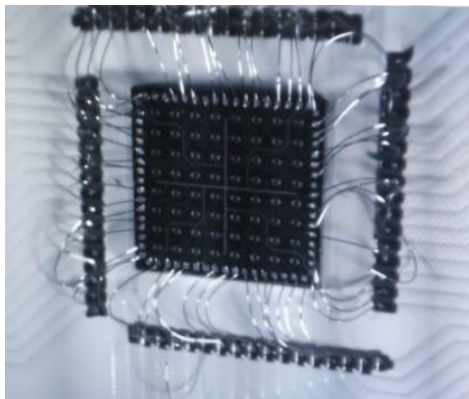
## Transmission in function of the dissipated power in the microheater



$$\% \text{ Transmission} = \frac{Phot_{\text{Transmission}}}{Phot_{\text{Transmission}} + Phot_{\text{Reflection}}}$$

## Compact system for the manipulation and detection of single photons

- Programmable PIC coupled with SPADs arrays
- Combines two custom technologies in order to optimize performance for each piece
- State-of-the-art performances at visible wavelength reaching  $SDE_{@V_{ov7}} = 41.9\%$



## NEXT STEPS

- Test thicker SPADs arrays
- Exploit 3D FLW to couple 2D SPAD arrays
- Realize a portable setup

# Thank you for your attention!



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